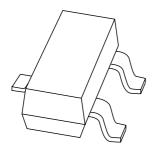
DISCRETE SEMICONDUCTORS

DATA SHEET



MMBT2222A NPN switching transistor

Product data sheet Supersedes data of 2000 Apr 11 2004 Jan 16



NPN switching transistor

MMBT2222A

FEATURES

- High current (max. 600 mA)
- Low voltage (max. 40 V).

APPLICATIONS

• Switching and linear amplification.

DESCRIPTION

NPN switching transistor in a SOT23 plastic package. PNP complement: PMBT2907A.

MARKING

| TYPE NUMBER | MARKING CODE ⁽¹⁾ | |
|-------------|-----------------------------|--|
| MMBT2222A | 7C* | |

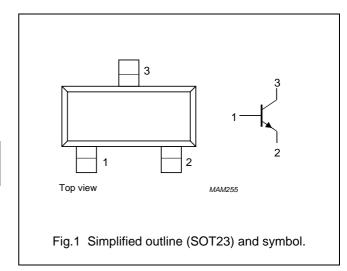
Note

* = p : Made in Hong Kong.
* = t : Made in Malaysia.

* = W : Made in China.

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | base |
| 2 | emitter |
| 3 | collector |



ORDERING INFORMATION

| TYPE | PACKAGE | | | | |
|-----------|---------|--|-------|--|--|
| NUMBER | NAME | DESCRIPTION VERSION | | | |
| MMBT2222A | _ | plastic surface mounted package; 3 leads | SOT23 | | |

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------------|----------------------------------|-----------------|------|------|
| V_{CBO} | collector-base voltage | open emitter | _ | 75 | V |
| V _{CEO} | collector-emitter voltage | open base | _ | 40 | V |
| V_{EBO} | emitter-base voltage | open collector | _ | 6 | V |
| I _C | collector current (DC) | | _ | 600 | mA |
| I _{CM} | peak collector current | | _ | 800 | mA |
| I _{BM} | peak base current | | _ | 200 | mA |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C; note 1 | _ | 250 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| T _j | junction temperature | | _ | 150 | °C |
| T _{amb} | operating ambient temperature | | - 65 | +150 | °C |

Note

1. Transistor mounted on an FR4 printed-circuit board.

NPN switching transistor

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THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|----------------------|---|------------|-------|------|
| R _{th(j-a)} | thermal resistance from junction to ambient | note 1 | 500 | K/W |

Note

1. Transistor mounted on an FR4 printed-circuit board.

CHARACTERISTICS

 $T_j = 25$ °C unless otherwise specified.

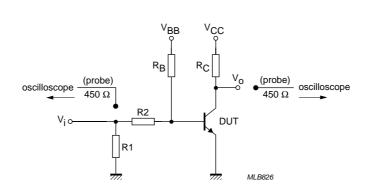
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | SYMBOL | PARAMETER CONDITIONS | | MIN. | MAX. | UNIT |
|---|--------------------|--|---|------|------|------|
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | I _{CBO} | collector cut-off current | I _E = 0; V _{CB} = 60 V | _ | 10 | nA |
| $\begin{array}{c} h_{FE} \\ h_{FE$ | | | I _E = 0; V _{CB} = 60 V; T _j = 125 °C | _ | 10 | μΑ |
| $ \begin{array}{ c c c c } \hline & I_{C} = 1 \text{ mA; } V_{CE} = 10 \text{ V} & 50 & - & & \\ \hline I_{C} = 10 \text{ mA; } V_{CE} = 10 \text{ V} & 75 & - & \\ \hline I_{C} = 10 \text{ mA; } V_{CE} = 10 \text{ V} & 75 & - & \\ \hline I_{C} = 10 \text{ mA; } V_{CE} = 10 \text{ V} & 35 & - & \\ \hline I_{C} = 10 \text{ mA; } V_{CE} = 10 \text{ V} & 35 & - & \\ \hline I_{C} = 150 \text{ mA; } V_{CE} = 10 \text{ V} & 100 & 300 & \\ \hline I_{C} = 150 \text{ mA; } V_{CE} = 10 \text{ V} & 50 & - & \\ \hline I_{C} = 150 \text{ mA; } V_{CE} = 10 \text{ V} & 40 & - & \\ \hline I_{C} = 500 \text{ mA; } V_{CE} = 10 \text{ V} & 40 & - & \\ \hline I_{C} = 500 \text{ mA; } V_{CE} = 10 \text{ V} & 40 & - & \\ \hline I_{C} = 500 \text{ mA; } V_{CE} = 10 \text{ V} & 40 & - & \\ \hline I_{C} = 500 \text{ mA; } V_{CE} = 10 \text{ V} & 40 & - & \\ \hline I_{C} = 500 \text{ mA; } V_{CE} = 10 \text{ V} & 40 & - & \\ \hline I_{C} = 500 \text{ mA; } V_{CE} = 10 \text{ V} & 40 & - & \\ \hline I_{C} = 500 \text{ mA; } V_{CE} = 10 \text{ V} & 40 & - & \\ \hline I_{C} = 500 \text{ mA; } V_{CE} = 10 \text{ V} & 40 & - & \\ \hline I_{C} = 500 \text{ mA; } V_{CE} = 10 \text{ V} & 40 & - & \\ \hline I_{C} = 500 \text{ mA; } V_{CE} = 10 \text{ V} & 40 & - & \\ \hline I_{C} = 500 \text{ mA; } V_{CE} = 10 \text{ V} & 40 & - & \\ \hline I_{C} = 500 \text{ mA; } V_{CE} = 10 \text{ V} & 10 & \\ \hline I_{C} = 500 \text{ mA; } V_{CE} = 10 \text{ V} & 10 & \\ \hline I_{C} = 500 \text{ mA; } I_{B} = 15 \text{ mA; note } & 1 & 0.6 & 1.2 & V \\ \hline I_{C} = 100 \text{ mA; } I_{B} = 15 \text{ mA; note } & 1 & 0.6 & 1.2 & V \\ \hline I_{C} = 100 \text{ mA; } I_{B} = 50 \text{ mA; note } & 1 & 0.6 & 1.2 & V \\ \hline I_{C} = 100 \text{ mA; } I_{B} = 50 \text{ mA; note } & 1 & 0.6 & 1.2 & V \\ \hline I_{C} = 100 \text{ mA; } V_{CE} = 10 \text{ V} & 1 & 0.6 & 1.2 & V \\ \hline I_{C} = 100 \text{ mA; } V_{CE} = 10 \text{ V} & 1 & 0.6 & 1.2 & V \\ \hline I_{C} = 100 \text{ mA; } V_{CE} = 10 \text{ V} & 1 & 0.6 & 1.2 & V \\ \hline I_{C} = 100 \text{ mA; } V_{CE} = 10 \text{ V} & 1 & 0.6 & 1.2 & V \\ \hline I_{C} = 100 \text{ mA; } V_{CE} = 20 \text{ V} & 1 & 0.6 & 1.2 & V \\ \hline I_{C} = 100 \text{ MHz} & 1 & 0.6 & 1.2 & 0.6 & 1.2 & 0.6 \\ \hline I_{C} = 100 \text{ MHz} & 1 & 0.6 & 1.2 & 0.6 & 0.6 \\ \hline I_{C} = 100 \text{ MHz} & 1 & 0.6 & 1.2 & 0.6 & 0.6 \\ \hline I_{C} = 100 \text{ MHz} & 1 & 0.6 & 1.2 & 0.6 & 0.6 \\ \hline I_{C} = 100 \text{ MHz} & 1 & 0.6 & 1.2 & 0.6 & 0.6 \\ \hline I_{C} = 100 \text{ MHz} & 1 & 0.6 & 0.6 & 0.$ | I _{EBO} | emitter cut-off current | I _C = 0; V _{EB} = 5 V | _ | 10 | nA |
| $ \begin{array}{ c c c c c } \hline & I_{C} = 10 \text{mA; } V_{CE} = 10 \text{V} & 75 & - & & \\ \hline I_{C} = 10 \text{mA; } V_{CE} = 10 \text{V; } \\ \hline I_{C} = 10 \text{mA; } V_{CE} = 10 \text{V; } \\ \hline I_{C} = 150 \text{mA; } V_{CE} = 10 \text{V} & 100 & 300 & \\ \hline I_{C} = 150 \text{mA; } V_{CE} = 10 \text{V} & 100 & 300 & \\ \hline I_{C} = 150 \text{mA; } V_{CE} = 10 \text{V} & 50 & - & \\ \hline I_{C} = 150 \text{mA; } V_{CE} = 10 \text{V} & 40 & - & \\ \hline I_{C} = 500 \text{mA; } V_{CE} = 10 \text{V} & 40 & - & \\ \hline I_{C} = 500 \text{mA; } V_{CE} = 10 \text{V} & 40 & - & \\ \hline I_{C} = 500 \text{mA; } I_{B} = 15 \text{mA; note } 1 & - & 300 & \text{mV} \\ \hline I_{C} = 500 \text{mA; } I_{B} = 15 \text{mA; note } 1 & - & 1 & V \\ \hline V_{DESat} & base-emitter saturation voltage & I_{C} = 150 \text{mA; } I_{B} = 15 \text{mA; note } 1 & - & 1 & V \\ \hline V_{DESat} & base-emitter saturation voltage & I_{C} = 150 \text{mA; } I_{B} = 15 \text{mA; note } 1 & - & 2 & V \\ \hline V_{C} & collector capacitance & I_{C} = 150 \text{mA; } I_{B} = 15 \text{mA; note } 1 & - & 2 & V \\ \hline I_{C} = 500 \text{mA; } I_{B} = 50 \text{mA; note } 1 & - & 2 & V \\ \hline I_{C} = 100 \text{mA; } V_{CB} = 10 \text{V; } & - & 8 & PF \\ \hline I_{T} & transition frequency & I_{C} = i_{C} = 0; V_{CB} = 500 \text{mV; } \\ \hline I_{T} & transition frequency & I_{C} = i_{C} = 0; V_{EB} = 500 \text{mV; } \\ \hline I_{T} & 100 \text{MHz} & 1 & - & 25 & PF \\ \hline \hline Switching time & I_{C} = 100 \mu\text{A; } V_{CE} = 20 \text{V; } \\ \hline I_{S} = 1 \text{kU; } f = 1 \text{kHz} & - & 4 & dB \\ \hline \hline Switching time & I_{C} = 100 \mu\text{A; } V_{CE} = 5 \text{V; } \\ \hline I_{S} = 1 \text{kU; } f = 1 \text{kHz} & - & 35 & \text{ns} \\ \hline I_{C} = 150 \text{mA; } I_{Bon} = 15 \text{mA; } \\ \hline I_{C} = 150 \text{mA; } I_{Bon} = 15 \text{mA; } \\ \hline I_{C} = 150 \text{mA; } I_{Bon} = 15 \text{mA; } \\ \hline I_{C} = 150 \text{mA; } I_{Bon} = 15 \text{mA; } \\ \hline I_{C} = 150 \text{mA; } I_{Bon} = 15 \text{mA; } \\ \hline I_{C} = 150 \text{mA; } I_{Bon} = 15 \text{mA; } \\ \hline I_{C} = 150 \text{mA; } I_{Bon} = 15 \text{mA; } \\ \hline I_{C} = 150 \text{mA; } I_{Bon} = 15 \text{mA; } \\ \hline I_{C} = 150 \text{mA; } I_{Bon} = 15 \text{mA; } \\ \hline I_{C} = 150 \text{mA; } I_{Bon} = 15 \text{mA; } \\ \hline I_{C} = 150 m$ | h _{FE} | DC current gain | I _C = 0.1 mA; V _{CE} = 10 V | 35 | _ | |
| $ \begin{array}{c c c c c c c c c c c c c c c c c c c $ | | | I _C = 1 mA; V _{CE} = 10 V | 50 | _ | |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | | | I _C = 10 mA; V _{CE} = 10 V | 75 | _ | |
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | | | | 35 | _ | |
| $ \begin{array}{ c c c c c } \hline & I_{C} = 500 \text{ mA; } V_{CE} = 10 \text{ V} & 40 & - & & & \\ \hline V_{CEsat} & collector-emitter saturation voltage & I_{C} = 150 \text{ mA; } I_{B} = 15 \text{ mA; note } 1 & - & 300 & \text{mV} \\ \hline I_{C} = 500 \text{ mA; } I_{B} = 50 \text{ mA; note } 1 & - & 1 & \text{V} \\ \hline I_{C} = 500 \text{ mA; } I_{B} = 50 \text{ mA; note } 1 & - & 1 & \text{V} \\ \hline V_{BEsat} & base-emitter saturation voltage & I_{C} = 150 \text{ mA; } I_{B} = 15 \text{ mA; note } 1 & - & 2 & \text{V} \\ \hline I_{C} = 500 \text{ mA; } I_{B} = 50 \text{ mA; note } 1 & - & 2 & \text{V} \\ \hline I_{C} = 500 \text{ mA; } I_{B} = 50 \text{ mA; note } 1 & - & 2 & \text{V} \\ \hline I_{C} = 500 \text{ mA; } I_{B} = 50 \text{ mA; note } 1 & - & 2 & \text{V} \\ \hline I_{C} = 100 \text{ mA; note } 1 & - & 2 & \text{V} \\ \hline I_{C} = I_{C} = I_{C} = I_{C} \times I_{C} \times I_{C} = 100 \text{ V; note } 1 \\ \hline I_{C} = I_{C} \times I_{C} \times I_{C} \times I_{C} = 100 \text{ V; note } 1 \\ \hline I_{C} = I_{C} \times I_{C} \times I_{C} \times I_{C} \times I_{C} = 100 \text{ MA; note } 1 \\ \hline I_{C} = I_{C} \times I_{C} \times I_{C} \times I_{C} \times I_{C} = 100 \text{ mA; note } 1 \\ \hline I_{C} = I_{C} \times $ | | | I _C = 150 mA; V _{CE} = 10 V | 100 | 300 | |
| $ \begin{array}{c} V_{CEsat} \\ V_{CEsat} \\ \end{array} \begin{array}{c} \text{Collector-emitter saturation voltage} \\ \end{array} \begin{array}{c} I_{C} = 150 \text{ mA; } I_{B} = 15 \text{ mA; note } 1 \\ I_{C} = 500 \text{ mA; } I_{B} = 50 \text{ mA; note } 1 \\ \end{array} \begin{array}{c} - 10 \\ 10 \\ \end{array} \begin{array}{c} V_{CEsat} \\ \end{array} \end{array} \begin{array}{c} \text{base-emitter saturation voltage} \\ \end{array} \begin{array}{c} I_{C} = 150 \text{ mA; } I_{B} = 15 \text{ mA; note } 1 \\ \end{array} \begin{array}{c} - 10 \\ \end{array} \begin{array}{c} 0.6 \\ 1.2 \\ \end{array} \begin{array}{c} V_{CEsat} \\ \end{array} \begin{array}{c} V_{CE$ | | | I _C = 150 mA; V _{CE} = 1 V | 50 | _ | |
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | | | I _C = 500 mA; V _{CE} = 10 V | 40 | _ | |
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | V _{CEsat} | collector-emitter saturation voltage | $I_C = 150 \text{ mA}$; $I_B = 15 \text{ mA}$; note 1 | _ | 300 | mV |
| $ \begin{array}{ c c c c c } \hline & & & & & & & & & & & & & & & & & & $ | | | $I_C = 500 \text{ mA}; I_B = 50 \text{ mA}; \text{ note } 1$ | _ | 1 | V |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | V _{BEsat} | base-emitter saturation voltage | $I_C = 150 \text{ mA}$; $I_B = 15 \text{ mA}$; note 1 | 0.6 | 1.2 | V |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | | | $I_C = 500 \text{ mA}$; $I_B = 50 \text{ mA}$; note 1 | _ | 2 | V |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | C _c | collector capacitance | | _ | 8 | pF |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | C _e | emitter capacitance | | _ | 25 | pF |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | f _T | transition frequency | | 300 | _ | MHz |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | F | noise figure | | _ | 4 | dB |
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | Switching ti | mes (between 10% and 90% levels); (see F | ig.2) | | • | |
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | t _{on} | turn-on time | I _{Con} = 150 mA; I _{Bon} = 15 mA; | _ | 35 | ns |
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | | delay time | | _ | 15 | ns |
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | <u> </u> | • | | _ | 20 | ns |
| t _s storage time – 200 ns | | turn-off time | | _ | 250 | ns |
| | | storage time | | _ | 200 | ns |
| | | fall time | | _ | 60 | ns |

Note

1. Pulse test: $t_p \leq 300~\mu s;~\delta \leq 0.02.$

NPN switching transistor

MMBT2222A



$$\begin{split} &V_i = 9.5 \ V; \ T = 500 \ \mu s; \ t_p = 10 \ \mu s; \ t_r = t_f \leq 3 \ ns. \\ &R1 = 68 \ \Omega; \ R2 = 325 \ \Omega; \ R_B = 325 \ \Omega; \ R_C = 160 \ \Omega. \\ &V_{BB} = -3.5 \ V; \ V_{CC} = 29.5 \ V. \\ &Oscilloscope: input impedance \ Z_i = 50 \ \Omega. \end{split}$$

Fig.2 Test circuit for switching times.

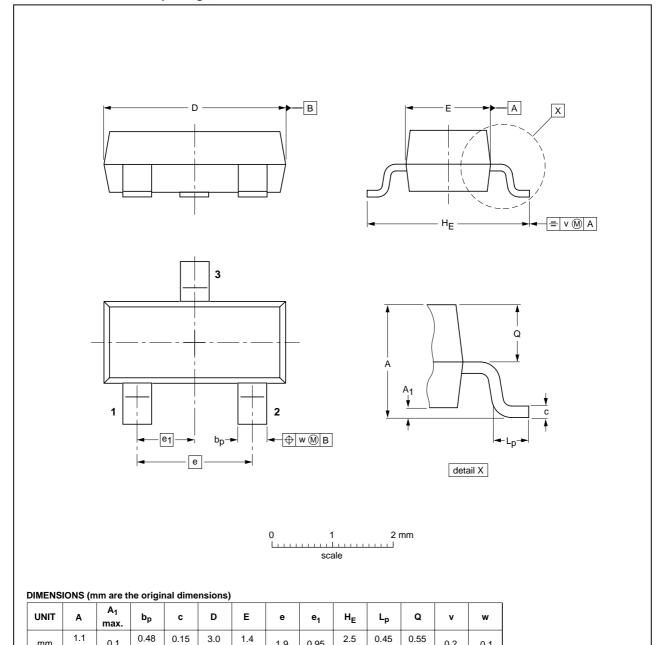
NPN switching transistor

MMBT2222A

PACKAGE OUTLINE

Plastic surface-mounted package; 3 leads

SOT23



| OUTLINE | REFERENCES | | EUROPEAN | ISSUE DATE | | |
|---------|------------|----------|----------|------------|------------|----------------------------------|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT23 | | TO-236AB | | | | -04-11-04 06-03-16 |

0.1

1.9

2004 Jan 16 5

0.38

0.9

NPN switching transistor

MMBT2222A

DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|-----------------------------------|----------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

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NXP Semiconductors

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Contact information

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For sales offices addresses send e-mail to: salesaddresses@nxp.com

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